

FAN5601

Regulated Step-Down Charge Pump DC/DC Converter

Features

- > 85% Peak Efficiency
- Low EMI
- Low Ripple
- Output Voltage 1.3V
- Input Voltage Range: 2.2V to 5.5V
- Output Current: Up to 250mA
- $\pm 2.5\%$ Output Voltage Accuracy
- 30 μ A Operating Current
- $I_{CC} < 1\mu$ A in Shutdown Mode
- 2MHz Operating Frequency
- Shutdown Isolates Output from Input
- Soft-Start Limits Inrush Current
- Short Circuit and Over Temperature Protection
- Minimum External Component Count
- 6-Lead 3x3mm MLP Package
- 8-Lead MSOP Package

Applications

- Cell Phones
- Handheld Computers
- Portable Electronic Equipment
- Core Supply to Next Generation Processors
- Low Voltage DC Bus
- Digital Cameras
- DSP Supplies

Description

The FAN5601 is an advanced third generation switched capacitor step down DC/DC converter utilizing Fairchild's proprietary ScalarPump™ technology. This innovative architecture utilizes scalar switch re-configuration and fractional switching techniques to produce low output ripple, low ESR spikes and improve efficiency over a wide load range.

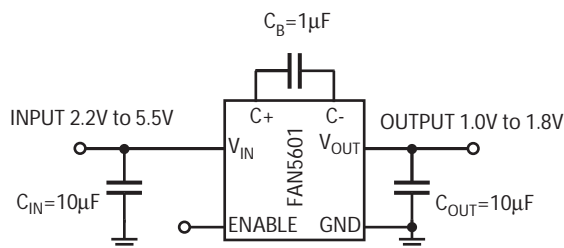
The FAN5601 produces a fixed regulated output from 2.2V to 5V input voltage. Customized output voltages are available in 100mV increments from 1V to 1.8V. Contact marketing for customized outputs.

In order to maximize efficiency, the FAN5601 achieves regulation by skipping pulses. Depending upon load current, the size of the switches is scaled dynamically, consequently, current spikes and EMI are minimized. An internal soft start circuitry prevents excessive current drawn from the supply. The device is internally protected against short circuit and over temperature conditions.

The FAN5601 is available in 6-lead 3x3mm MLP and 8-lead MSOP packages.

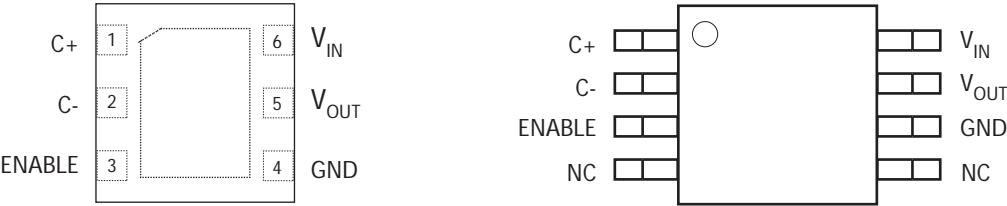
ScalarPump™ is a registered trademark of Fairchild Semiconductor Corporation

Typical Application



Pin Assignment

Top-View



FAN5601

6-Lead 3x3mm MLP

8-Lead MSOP

Pin Description

| Pin No. | Pin Name | | Pin Function Description |
|---------|------------------|------------------|--------------------------------------|
| | 6-Lead 3x3mm MLP | 8-Lead MSOP | |
| 1 | C+ | C+ | Bucket Capacitor Positive Connection |
| 2 | C- | C- | Bucket Capacitor Negative Connection |
| 3 | ENABLE | ENABLE | Enable Pin |
| 4 | GND | NC | No Connection |
| 5 | V _{OUT} | NC | No Connection |
| 6 | V _{IN} | GND | Ground |
| 7 | | V _{OUT} | Output |
| 8 | | V _{IN} | Input |

Absolute Maximum Ratings (Note1)

| Parameter | Min | Max | Unit |
|--|------|----------------|------|
| $V_{IN}, V_{OUT}, \text{ENABLE to GND}$ | -0.3 | 6.0 | V |
| C+, C-, to GND | -0.3 | $V_{IN} + 0.3$ | V |
| V_{OUT} Short Circuit Duration | | INDEFINITE | |
| Lead Soldering Temperature (10 seconds) | | 300 | °C |
| Operating Temperature Range | -40 | +85 | °C |
| Junction Temperature | | 150 | °C |
| Storage Temperature | -55 | 150 | °C |
| Electrostatic Discharge (ESD) Protection (Note2) | HBM | 4 | kV |
| | CDM | 1 | |

Recommended Operating Conditions

| Parameter | Package | Min | Typ | Max | Unit |
|--|------------------------------|-----|-----|-----|------|
| Input Voltage | | 2.2 | | 5.5 | V |
| Output Current | | | | 250 | mA |
| Operating Ambient Temperature | | -40 | | 85 | °C |
| Thermal Resistance Junction to Tab | 6-lead 3x3mm MLP | | 8 | | °C/W |
| Thermal Resistance Junction to Ambient | 6-lead 3x3mm MLP (Note 3) | | 90 | | °C/W |
| | 8-lead MSOP | | 150 | | °C/W |

Notes:

1. Operation beyond the absolute maximum rating may cause permanent damage to device.
2. Using Mil Std. 883E, method 3015.7(Human Body Model) and EIA/JESD22C101-A (Charge Device Model).
3. One square inch, 1oz bottom side GND plane connected to top side GND plane by field of via.

Electrical Characteristics

V_{IN} = 2.2V to 5.5V, I_{OUT} = 1mA, C_B = 1 μ F, C_{IN} = 10 μ F, C_{OUT} = 10 μ F, T_A = -40°C to +85°C, typical values measured at T_A = 25°C, unless otherwise noted.

| Parameter | Conditions | Min. | Typ. | Max. | Units |
|---|---|------|-------|------|---------|
| Input Undervoltage Lockout | | 1.9 | 2.0 | 2.15 | V |
| Output Voltage | | | 1.3 | | V |
| Output Voltage Accuracy | T_A = 25°C, V_{IN} = 3.3V | -2 | | +2 | % |
| | V_{IN} = 3.3V | -2.5 | | +2.5 | % |
| Output Voltage Temperature Coefficient | V_{IN} = 3.3V | | 25 | | ppm |
| Load Regulation | | | 0.133 | | mV/mA |
| Line Regulation | T_A = 25°C | | 1.35 | 2 | mV/V |
| No load Supply Current (Note 4) | I_{OUT} = 0mA, V_{IN} = 2.2V | | 30 | 60 | μ A |
| Shutdown Supply Current | ENABLE = GND. V_{OUT} = 0 | | 0.1 | 1 | μ A |
| Output Short-circuit Current (Note 5) | V_{OUT} = GND. | | 25 | | mA |
| Efficiency | V_{IN} = $2.35 \times V_{OUT}$ I_{OUT} = 150mA | | 85 | | % |
| V_{IN} at Configuration Change | From 2:1 to 1:1 mode V_{OUT} = 1.3V | | 3.06 | | V |
| Oscillator Frequency | | | 2.0 | | MHz |
| Thermal Shutdown Threshold | | | 150 | | °C |
| Thermal Shutdown Threshold Hysteresis | | | 15 | | °C |
| ENABLE Logic Input High Voltage, V_{IH} | V_{IN} = 2.2V to 5.5V | 1.3 | | | V |
| ENABLE Logic Input Low Voltage, V_{IL} | V_{IN} = 2.2V to 5.5V | | | 0.4 | V |
| ENABLE Logic Input Current | ENABLE = V_{IN} or GND | -1 | | 1 | μ A |
| V_{OUT} Turn On Time | V_{IN} = 3.6V, I_{OUT} = 0mA, 10% to 90% | | 1 | | mS |

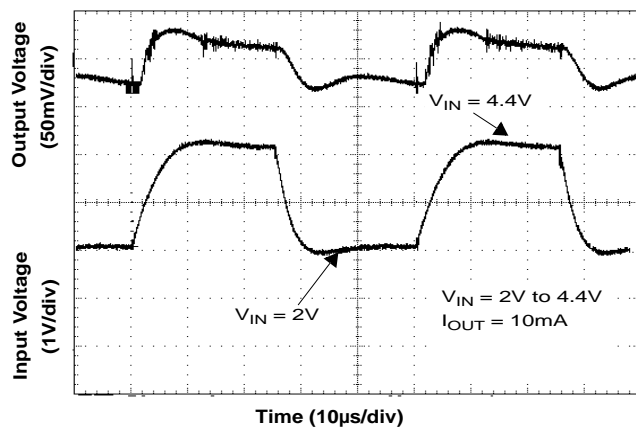
Notes:

- No load supply current is measured when the oscillator is off.
- The short circuit protection is designed to protect against pre-existing short circuit conditions, i.e. assembly shorts that exist prior to device power-up. The short circuit current limit is 25mA_{Average}. Short circuit currents in normal operation are inherently limited by the ON-resistance of internal device. Since this resistance is in the range of 1 Ω , in some cases thermal shutdown may occur. However, immediately following the first thermal shutdown event, the short circuit condition will be treated as pre-existing, and the load current will reduce to 25mA_{Average}.

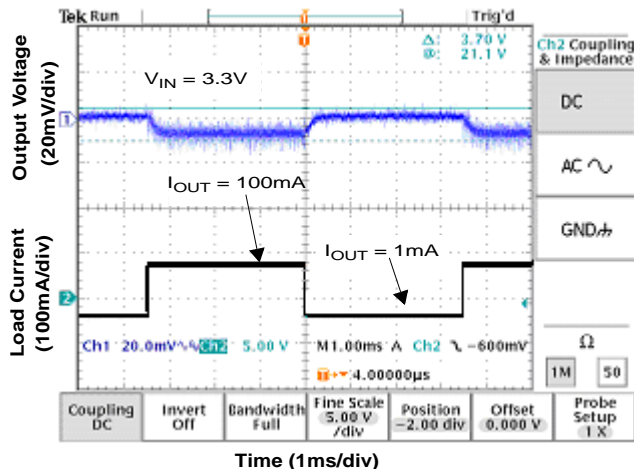
Typical Performance Characteristics

$T_A = 25^\circ\text{C}$, $C_{IN} = C_{OUT} = 10\mu\text{F}$, $C_B = 1\mu\text{F}$, unless otherwise noted.

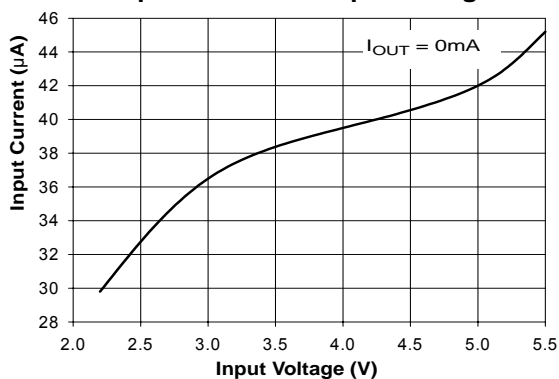
Line Transient Response



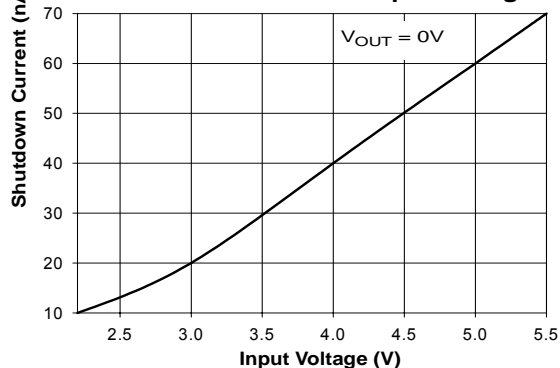
Load Transient Response



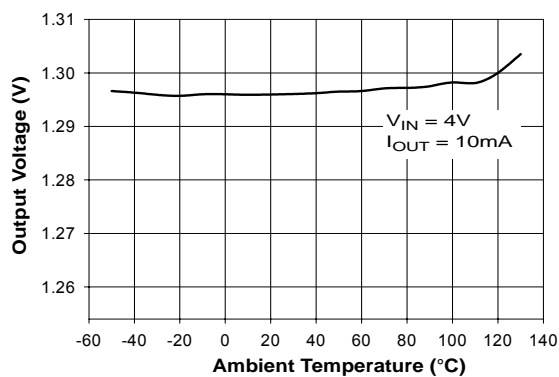
Input Current vs Input Voltage



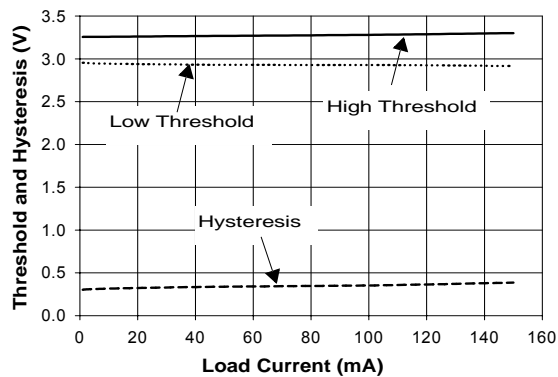
Shutdown Current vs Input Voltage



Output Voltage vs Ambient Temperature



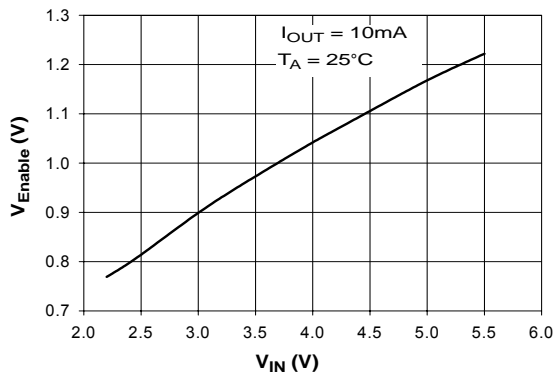
Mode Change Threshold and Hysteresis vs Load Current



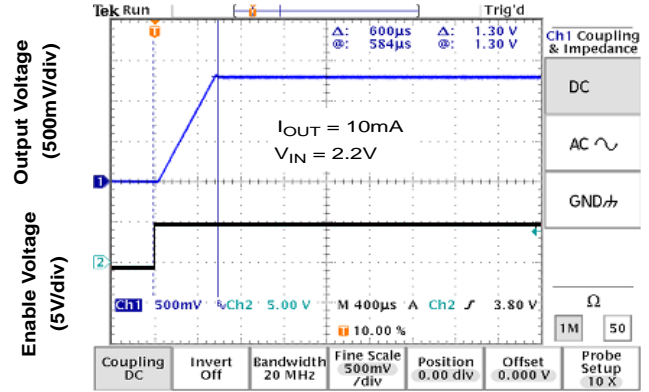
Typical Performance Characteristics (cont.)

$T_A = 25^\circ\text{C}$, $C_{IN} = C_{OUT} = 10\mu\text{F}$, $C_B = 1\mu\text{F}$, unless otherwise noted.

Enable Threshold vs Input Voltage

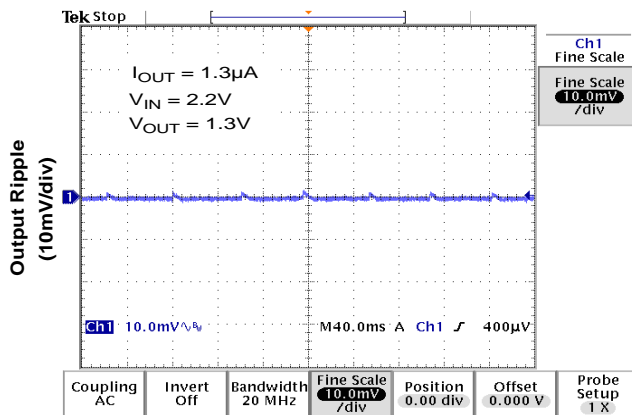


Enable Delay



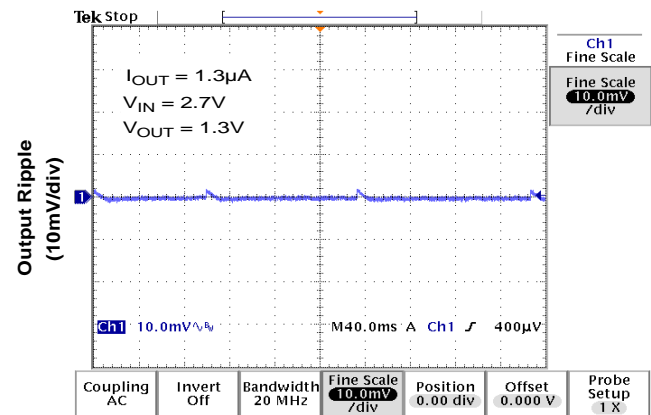
Time (400 μs /div)

Output Ripple



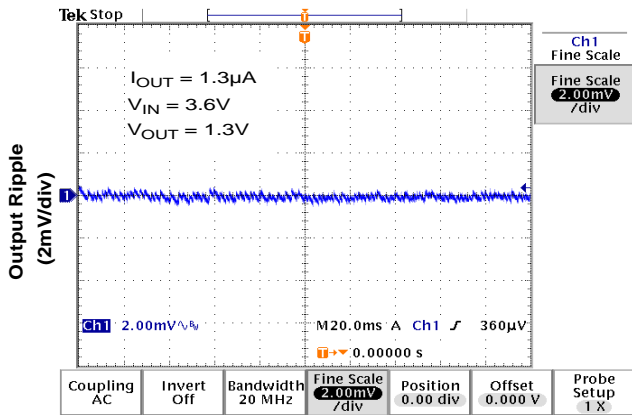
Time (40ms/div)

Output Ripple



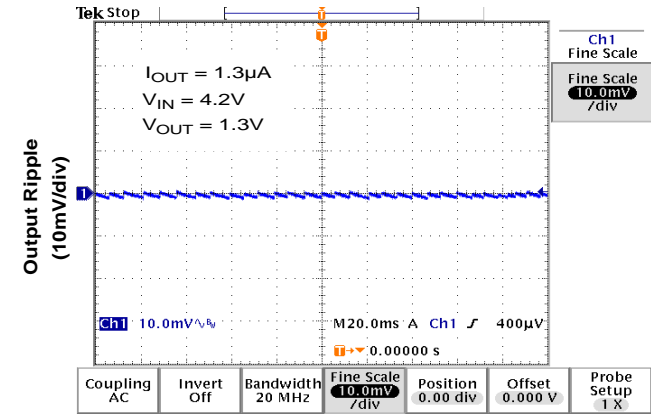
Time (40ms/div)

Output Ripple



Time (20ms/div)

Output Ripple

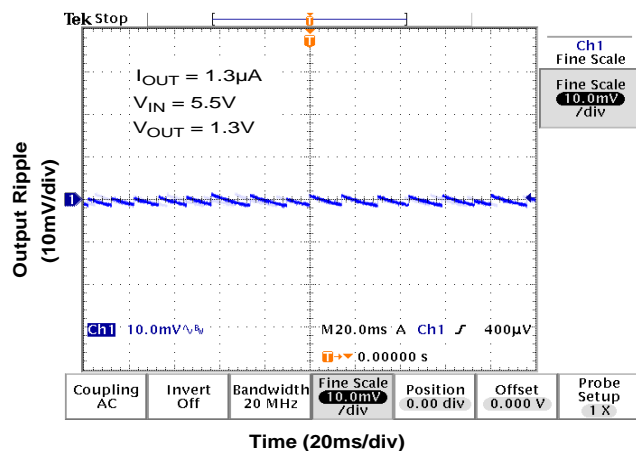


Time (20ms/div)

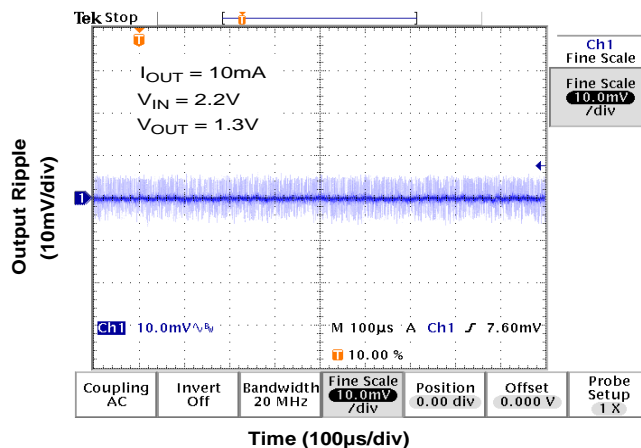
Typical Performance Characteristics (cont.)

$T_A = 25^\circ\text{C}$, $C_{IN} = C_{OUT} = 10\mu\text{F}$, $C_B = 1\mu\text{F}$, unless otherwise noted.

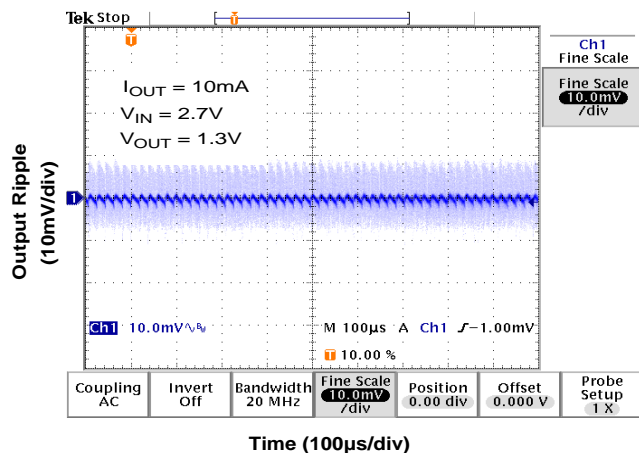
Output Ripple



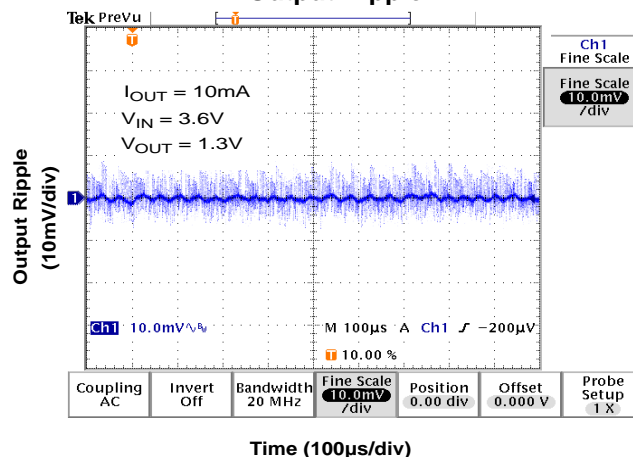
Output Ripple



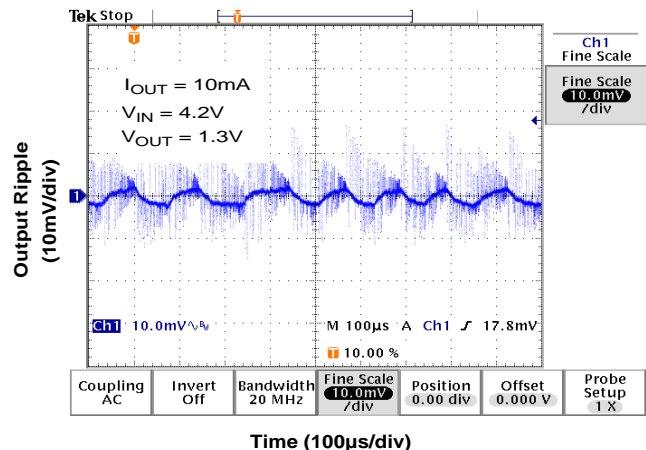
Output Ripple



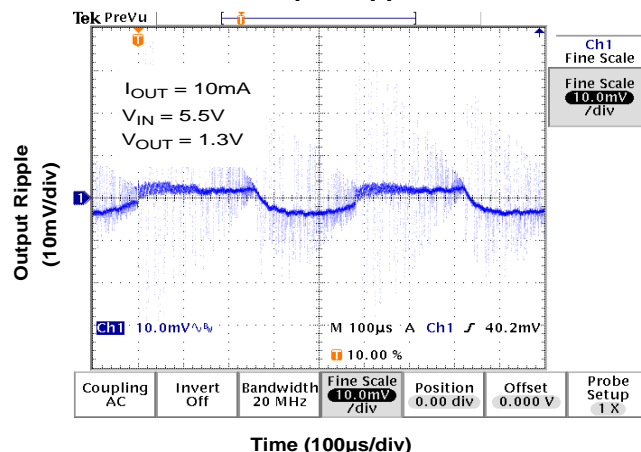
Output Ripple



Output Ripple

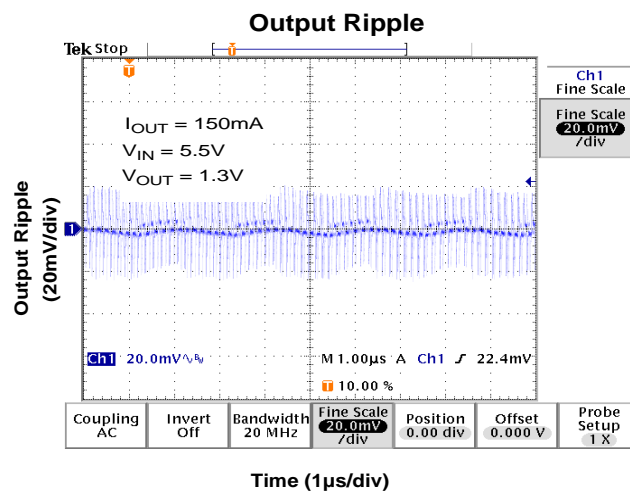
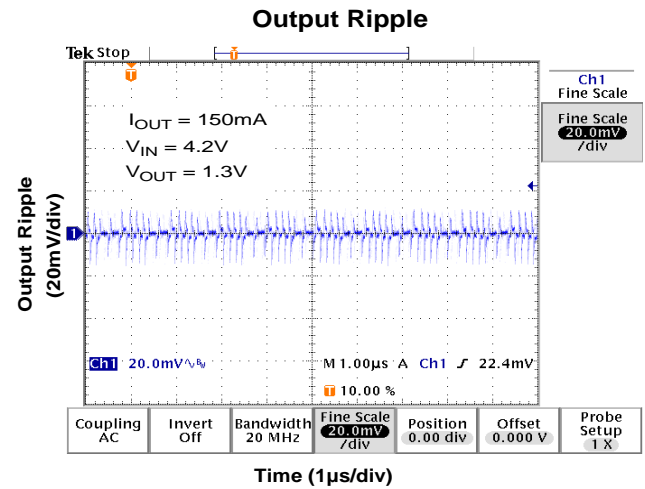
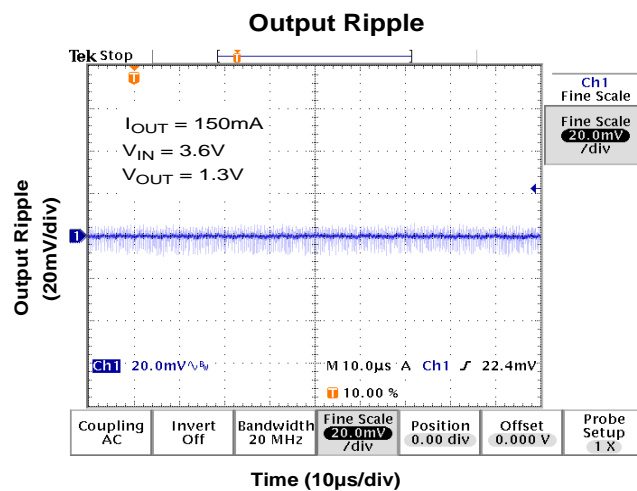
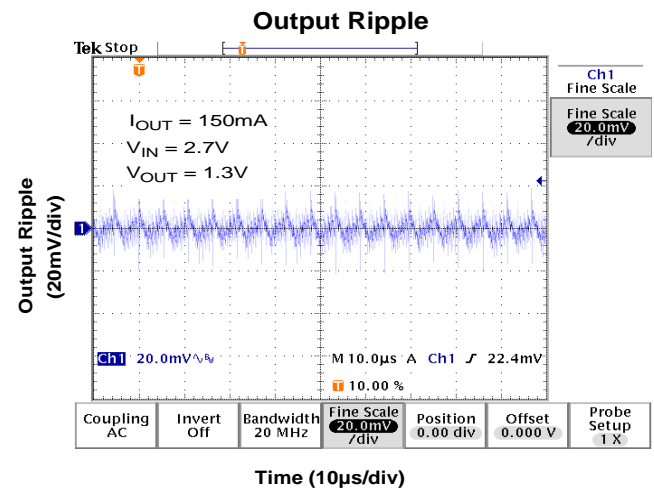
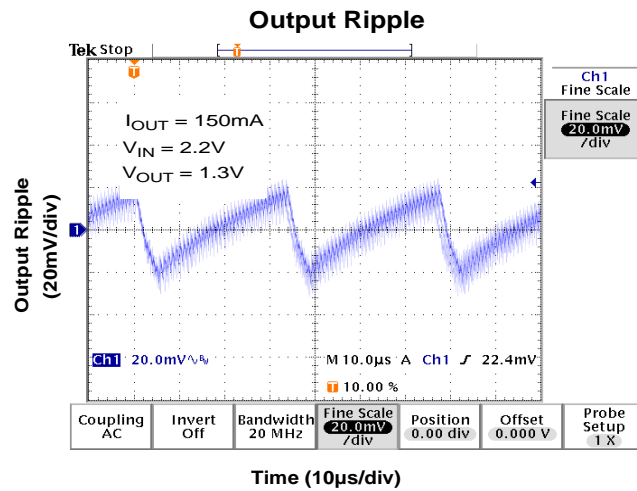


Output Ripple



Typical Performance Characteristics (cont.)

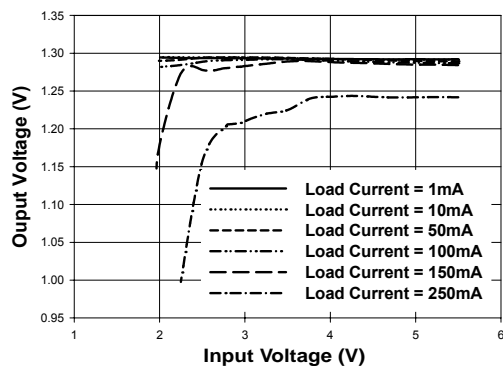
$T_A = 25^\circ\text{C}$, $C_{IN} = C_{OUT} = 10\mu\text{F}$, $C_B = 1\mu\text{F}$, unless otherwise noted.



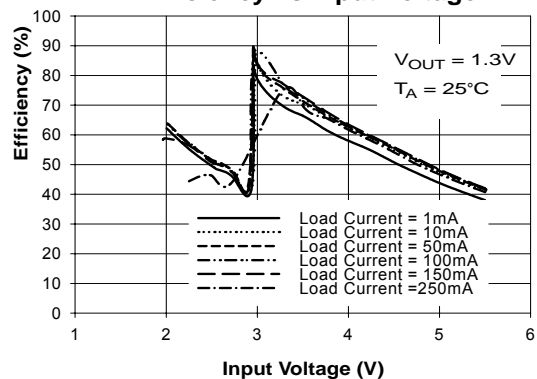
Typical Performance Characteristics (cont.)

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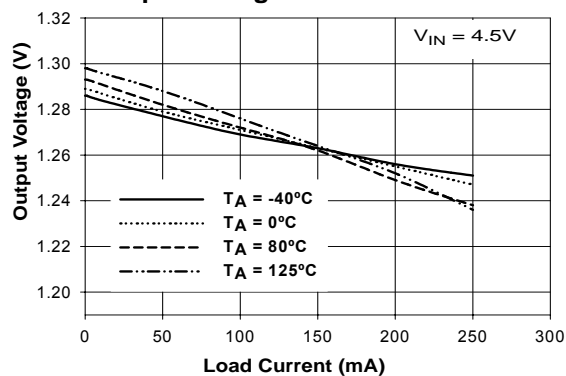
Output Voltage vs Input Voltage



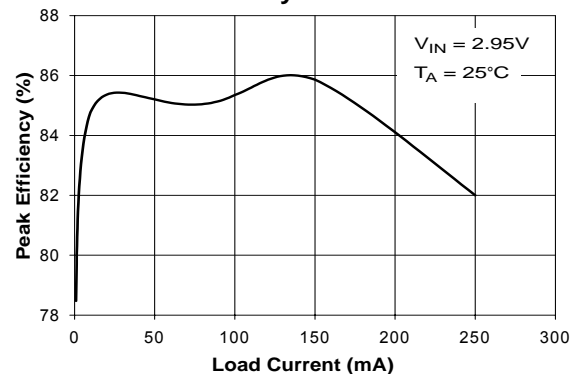
Efficiency vs Input Voltage



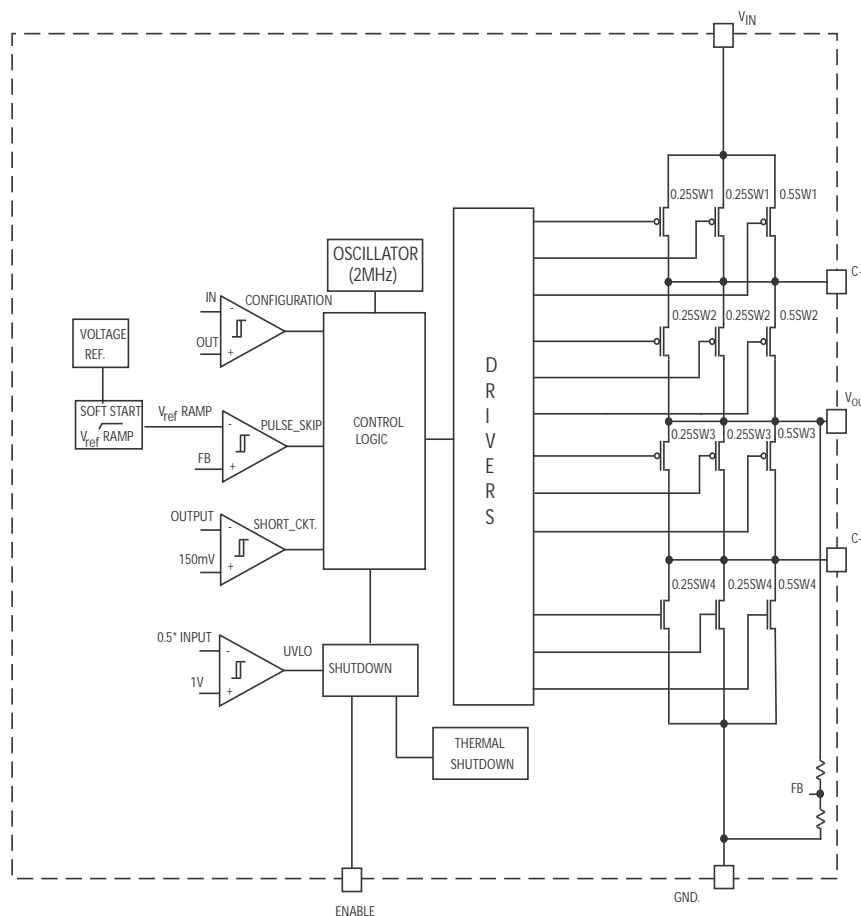
Output Voltage vs Load Current



Peak Efficiency vs Load Current



Block Diagram



Detailed Description

The FAN5601 switched capacitor DC/DC converter automatically configures switches to achieve a high efficiency and provides a regulated output voltage by means of pulse skipping, pulse frequency modulation (PFM). An internal soft start circuit prevents excessive inrush current drawn from the supply. Each switch is split into three segments. Based on the values of V_{IN} , V_{OUT} and I_{OUT} , an internal circuitry determines the number of segments to be used to reduce current spikes.

Step-Down Charge Pump Operation

When $V_{IN} \geq 2 \times V_{OUT}/0.9$, a 2:1 configuration shown in Fig.1(A) is enabled. The factor 0.9 is used instead of 1 in order to account for the effect of resistive losses across the switches and to accommodate hysteresis in the voltage detector comparator. Two phase non-overlapping clock signals are generated to drive four switches. When switches 1 and 3 are ON, switches 2 and 4 are OFF and C_B is charged. When switches 2 and 4 are ON, switches 1 and 3 are OFF, charge is transferred from C_B to C_{OUT} .

When $V_{IN} < 2 \times V_{OUT}/0.9$, a 1:1 configuration shown in Fig. 1(B) is enabled. In the 1:1 configuration switch 3 is always OFF and the switch 4 is always ON. At 1.6V output setting the configuration changes from 2:1 to 1:1 at $V_{IN} = 3.56V$. At 1.3V output setting the change occurs at $V_{IN} = 3.06V$.

Pulse-skipping PFM and Fractional Switch Operation

When the regulated output voltage reaches its upper limit, the switches are turned off the output voltage reaches its lower limit. Considering a step-down 2:1 mode of operation, 1.6V output as an example, when the output reaches about 1.62V(upper limit), the control logic turns off all switches. Switching stops completely. This is pulse-skipping mode. Since the supply is isolated from the output, the output voltage will drop. Once the output is dropped to about 1.58V(lower limit), the device will return to regular switching mode with one quarter of each switch turning on first. Another quarter of each switch will be turned on if V_{OUT} cannot reach regulation by the time of arrival of the third

Switch Configuration

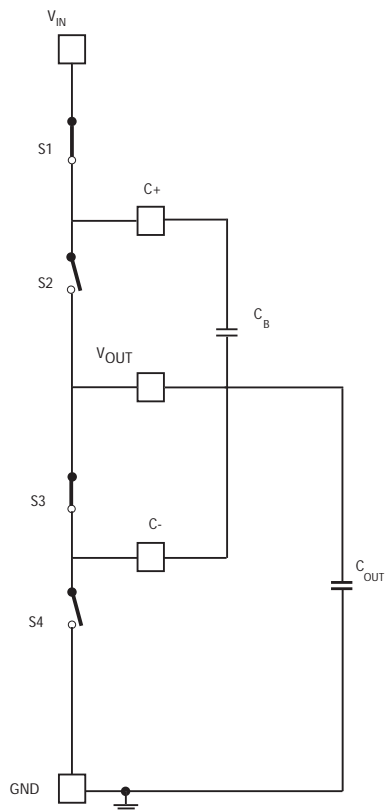


Figure. 1(A)
2:1 configuration
Switches in charging phase
Reverse all switches for pumping phase

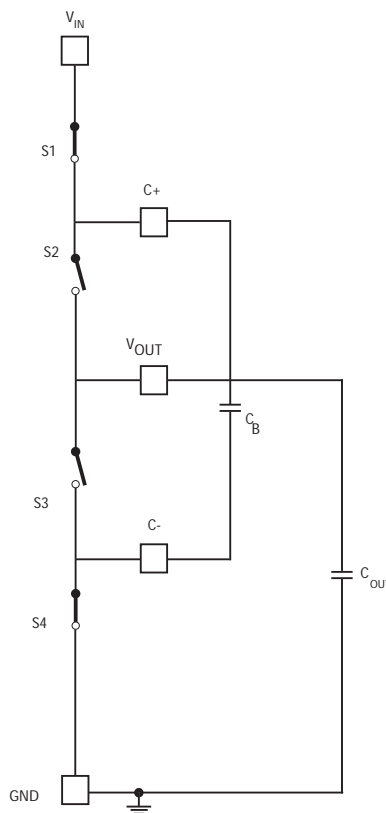


Figure. 1(B)
1:1 configuration
Switch 3 is always off and
Switch 4 is always on
Switches 1 and 2 are in phase 1
Reverse the position of switches 1&2
for phase 2

charge cycle. Full switch operation occurs only during start-up or under heavy load condition, when half switch operation cannot achieve regulation within seven charge cycles.

Soft Start

The soft-start feature limits inrush current when the device is initially powered up and enabled. The reference voltage is used to control the rate of the output voltage ramp-up to its final value. Typical start-up time is 1ms. Since the rate of the output voltage ramp-up is controlled by an internally generated slow ramp, pulse-skipping occurs and inrush current is automatically limited.

Shutdown, UVLO, Short Circuit Current Limit and Thermal Shutdown

The device has an active-low shutdown pin to decrease supply current to less than 1μA. In shutdown mode the supply is disconnected from the output. UVLO triggers when supply voltage drops below 2V. When the output voltage is lower than 150mV, a short circuit protection is triggered. In this mode 15 out of 16 pulses during the switching will be skipped and the supply current is limited. Thermal shutdown triggers at 150°C.

Applications Information

Proper operation of the FAN5601 requires one ceramic bucket capacitor in the 0.1 μ F to 1 μ F range; one 10 μ F output bypass capacitor and one 10 μ F input bypass capacitor. In order to obtain optimum output ripple and noise performance, use of low ESR (<0.05 Ω) ceramic input and output bypass capacitors is recommended. The X5R and X7R rated capacitors provide adequate performance over the -40°C to 85°C temperature range.

The value of the bucket capacitor is dependent on load current requirements. A 1 μ F bucket capacitor will work well in all applications at all load currents, while a 0.1 μ F capacitor will support most applications under 100mA of load current. The choice of bucket capacitor values should be verified in the actual application at the lowest input voltage and highest load current. A 30% margin of safety is recommended in order to account for the tolerance of the bucket capacitor and the variations in the on-resistance of the internal switches.

One of the key benefits of the ScalarPump™ architecture is that the dynamically scaled on-resistance of the switches effectively reduces the peak current in the bucket capacitor and therefore input and output ripple current is also reduced. Nevertheless, due to the ESR of the input and output bypass capacitors, these current spikes generate voltage spikes at the input and output pins. However, these ESR spikes can be easily filtered because their frequency lie at up to 12 times the clock frequency. In applications where conductive and radiated EMI/RFI interference has to be kept as low as possible, the user may consider the use of additional input and output filtering. For example, adding an L-C filter to the standard output bypass configuration is very effective in reducing both the output ripple and the voltage spikes. Figure 2 shows an L-C filter using a 100nH chip inductor and a

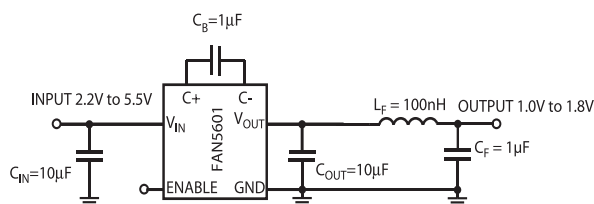


Figure 2. Optional L-C Filter

1 μ F capacitor. The channel 1 of Figure 3 shows the ripple voltage at the output of the device while Channel 2 shows the

ripple voltage at the output of the filter at $V_{IN} = 3.3V$, $V_{OUT} = 1.3V$ and $I_{OUT} = 100mA$. Similar filtering method will greatly reduce the current spikes at the input. The user should be mindful of considering resistive voltage drops in the inductors connected serially in the input and output leads.

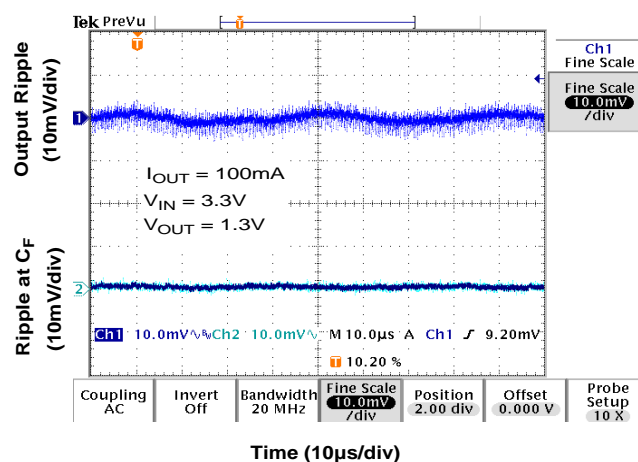
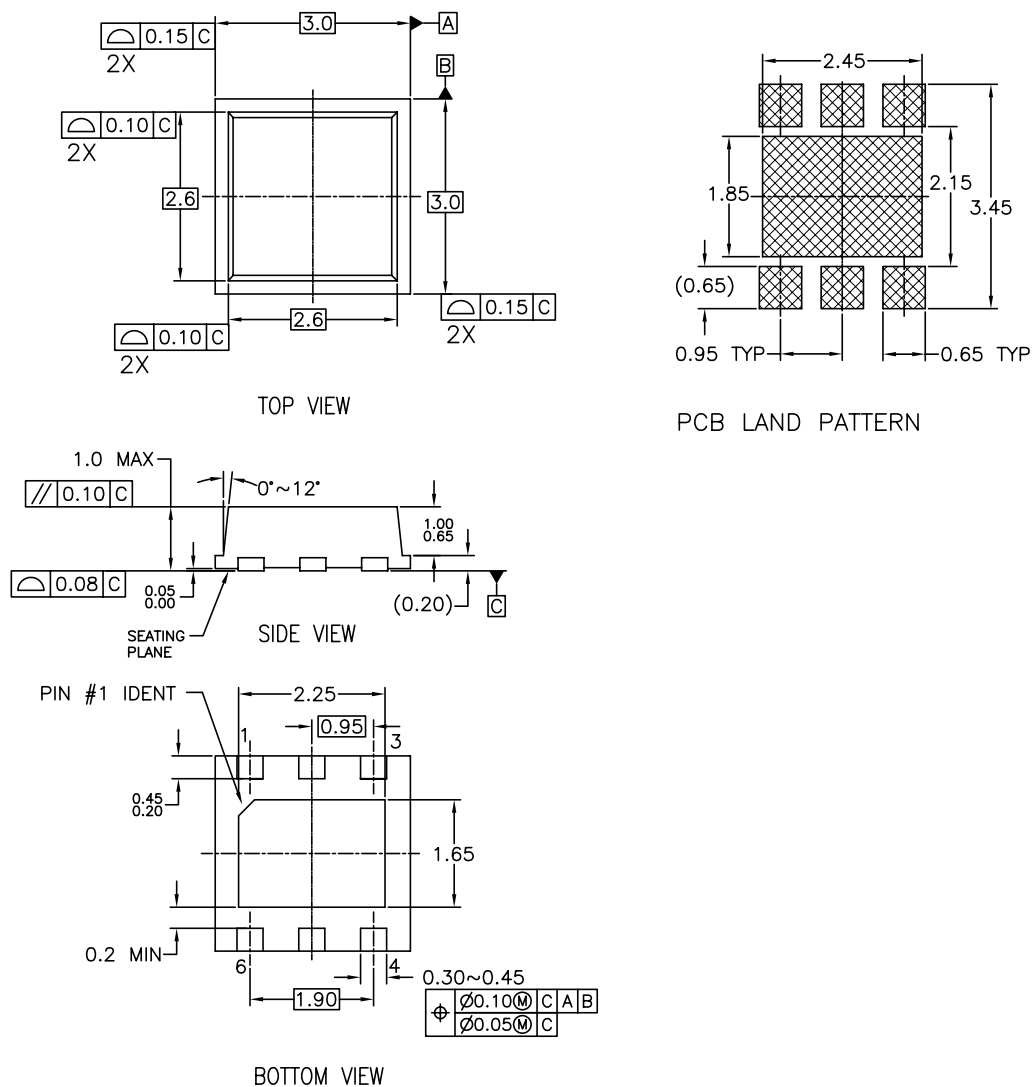


Figure 3. Effect of L-C Filter on output ripple

While evaluating the FAN5601 (or any other switched capacitor DC-DC converter) the user should be careful to keep the power supply source impedance low; use of long wires causing high lead inductances and resistive losses should be avoided. A carefully laid out ground plane is essential because current spikes are generated as the bucket capacitor is charged and discharged. The input and output bypass capacitors should be placed as close to the device pins as possible.

Mechanical Dimensions

6-Lead 3x3mm MLP Package



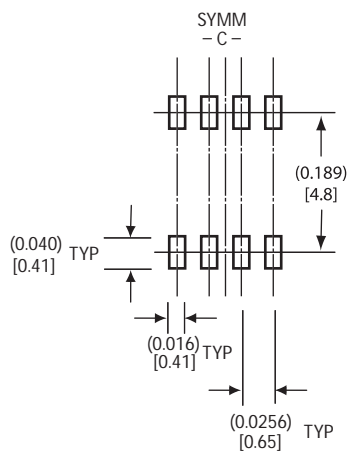
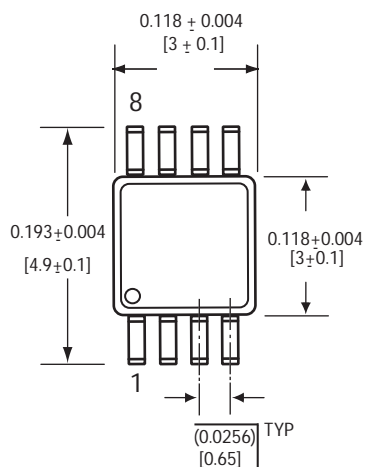
NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION VEEA, DATED 11/2001
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

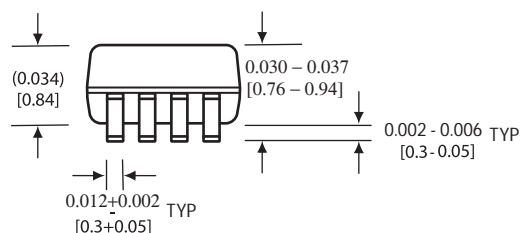
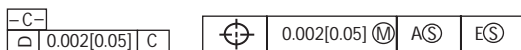
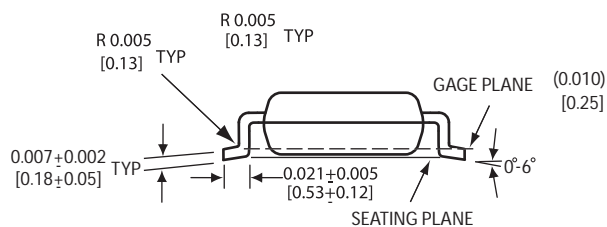
MLP006ArevA

Mechanical Dimensions

8-Lead MSOP Package



PCB LAND PATTERN



Ordering Information

| Product Number | Package Type | Voltage Option | Order Code |
|----------------|------------------|----------------|--------------|
| FAN5601 | 6-Lead 3x3mm MLP | 1.3V | FAN5601MP13X |
| | 8-Lead MSOP | 1.3V | FAN5601MU13X |

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.